

RoHS Compliant Product

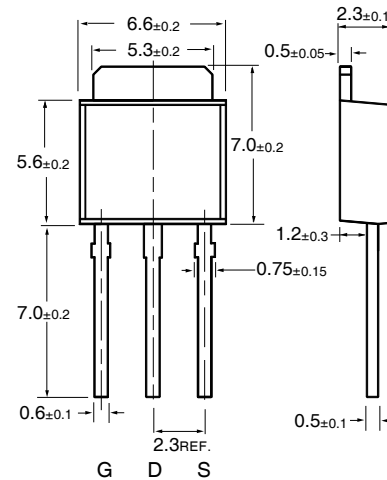
Description

The SID9960 provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

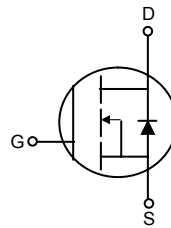
Features

- * Low Gate Charge
- * Simple Drive Requirement
- * Fast Switching

TO-251



Dimensions in millimeters



Marking Code: 9960

XXXX(Date Code)

Absolute Maximum Ratings

Parameter	Symbol	Ratings	Unit
Drain-Source Voltage	V_{DS}	40	V
Gate-Source Voltage	V_{GS}	± 20	V
Continuous Drain Current, $V_{GS}@10V$	$I_D@T_C=25^\circ C$	42	A
Continuous Drain Current, $V_{GS}@10V$	$I_D@T_C=100^\circ C$	26	A
Pulsed Drain Current ¹	I_{DM}	195	A
Total Power Dissipation	$P_D@T_C=25^\circ C$	45	W
Linear Derating Factor		0.36	W/ $^\circ C$
Operating Junction and Storage Temperature Range	T_j, T_{stg}	-55~+150	$^\circ C$

Thermal Data

Parameter	Symbol	Ratings	Unit
Thermal Resistance Junction-case	R_{thj-c}	2.8	$^\circ C/W$
Thermal Resistance Junction-ambient	R_{thj-a}	110	$^\circ C/W$

Electrical Characteristics(T_j=25°C Unless otherwise specified)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test Condition
Drain-Source Breakdown Voltage	BV _{DSS}	40	-	-	V	V _{GS} =0V, I _D =250uA
Breakdown Voltage Temp. Coefficient	ΔBV _{DSS} /ΔT _j	-	0.032	-	V/°C	Reference to 25°C, I _D =1mA
Gate Threshold Voltage	V _{GS(th)}	1.0	-	3.0	V	V _{DS} =V _{GS} , I _D =250uA
Gate-Source Leakage Current	I _{GSS}	-	-	±100	nA	V _{GS} =±20V
Drain-Source Leakage Current (T _j =25°C)	I _{DSS}	-	-	1	uA	V _{DS} =40V, V _{GS} =0
Drain-Source Leakage Current(T _j =150°C)		-	-	25	uA	V _{DS} =32V, V _{GS} =0
Static Drain-Source On-Resistance	R _{DS(ON)}	-	-	16	mΩ	V _{GS} =10V, I _D =20A
		-	-	25		V _{GS} =4.5V, I _D =18A
Total Gate Charge ²	Q _g	-	18	-	nC	I _D =20A V _{DS} =20V V _{GS} = 4.5V
Gate-Source Charge	Q _{gs}	-	6	-		
Gate-Drain ("Miller") Charge	Q _{gd}	-	12	-		
Turn-on Delay Time ²	T _{d(ON)}	-	9	-	nS	V _{DD} =20V I _D =20A V _{GS} =10V R _G =3.3Ω R _D =1 Ω
Rise Time	T _r	-	110	-		
Turn-off Delay Time	T _{d(OFF)}	-	23	-		
Fall Time	T _f	-	10	-		
Input Capacitance	C _{iss}	-	1500	-	pF	V _{GS} =0V V _{DS} =25V f=1.0MHz
Output Capacitance	C _{oss}	-	250	-		
Reverse Transfer Capacitance	C _{rss}	-	180	-		
Forward Transconductance	G _{fs}	-	30	-	S	V _{DS} =10V, I _D =20A

Source-Drain Diode

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test Condition
Forward On Voltage ²	V _{SD}	-	-	1.3	V	I _S =45 A, V _{GS} =0V.
Reverse Recovery Time	T _{rr}	-	22	-	nS	I _S =20A, V _{GS} =0V. dI/dt=100A/us
Reverse Recovery Charge	Q _{rr}	-	27.4	-	nC	

Notes: 1.Pulse width limited by safe operating area.

2.Pulse width ≤300us, dutycycle≤2%.

Characteristics Curve

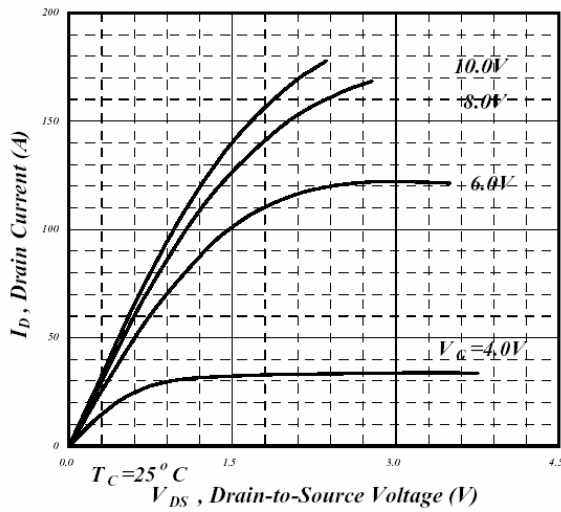


Fig 1. Typical Output Characteristics

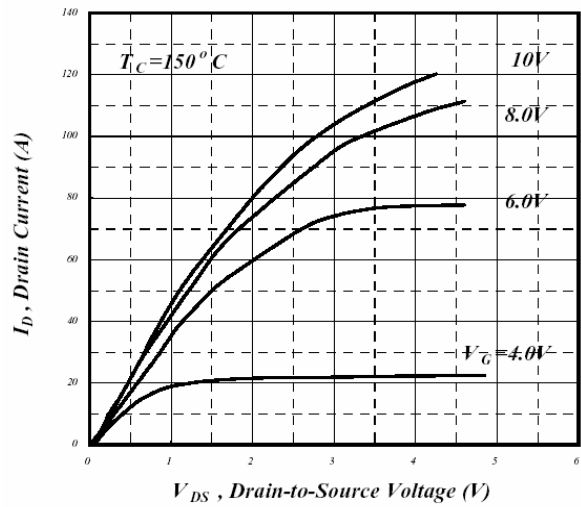


Fig 2. Typical Output Characteristics

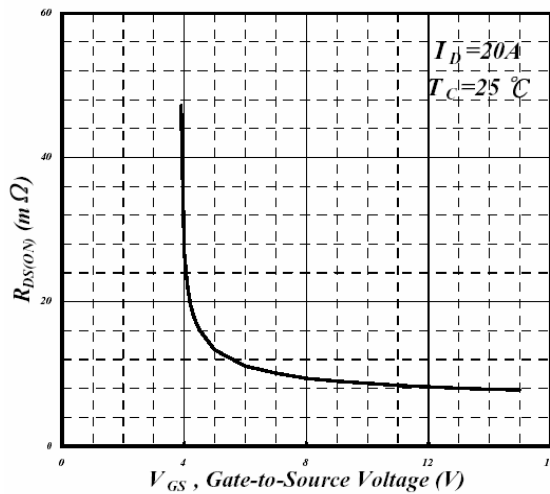


Fig 3. On-Resistance v.s. Gate Voltage

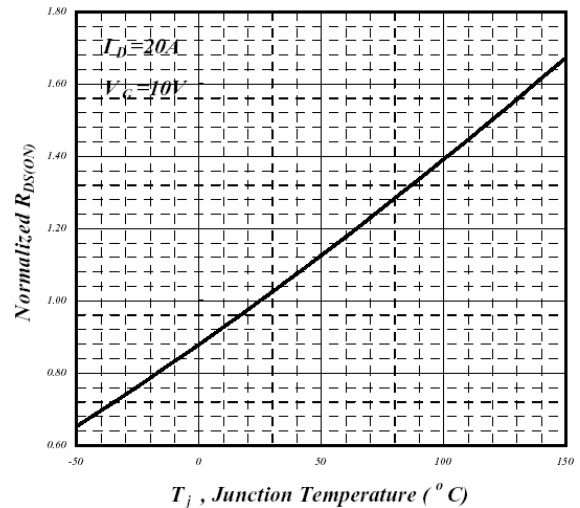


Fig 4. Normalized On-Resistance v.s. Junction Temperature

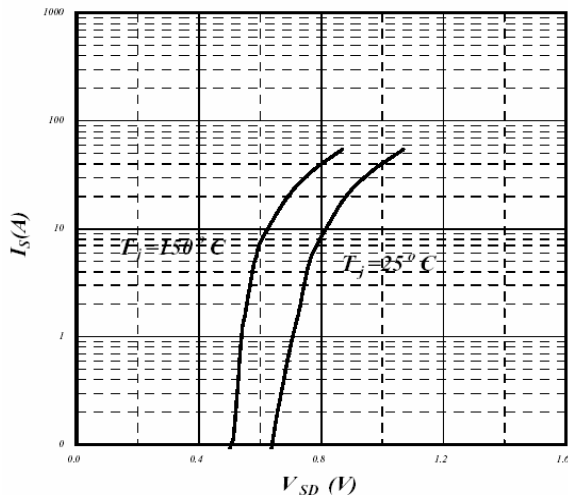


Fig 5. Forward Characteristic of Reverse Diode

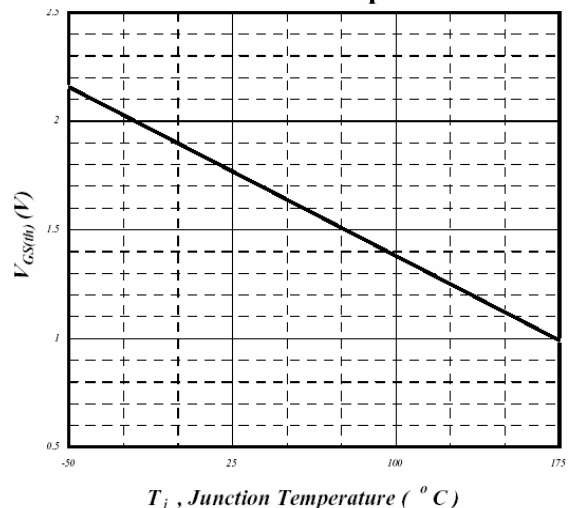


Fig 6. Gate Threshold Voltage v.s. Junction Temperature

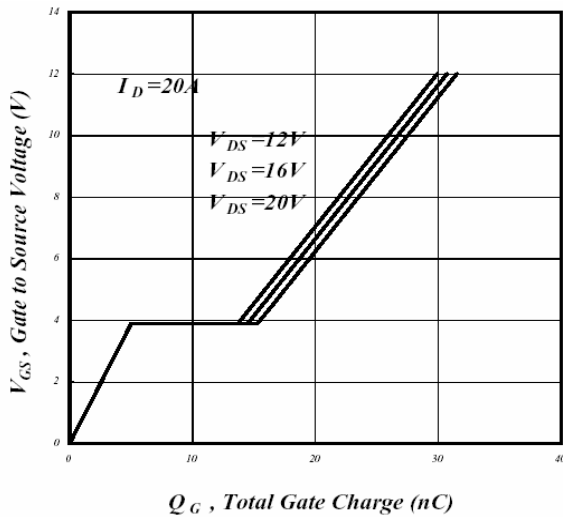


Fig 7. Gate Charge Characteristics

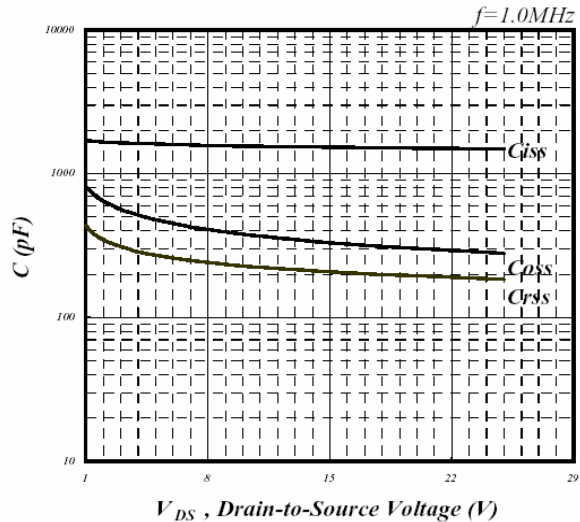


Fig 8. Typical Capacitance Characteristics

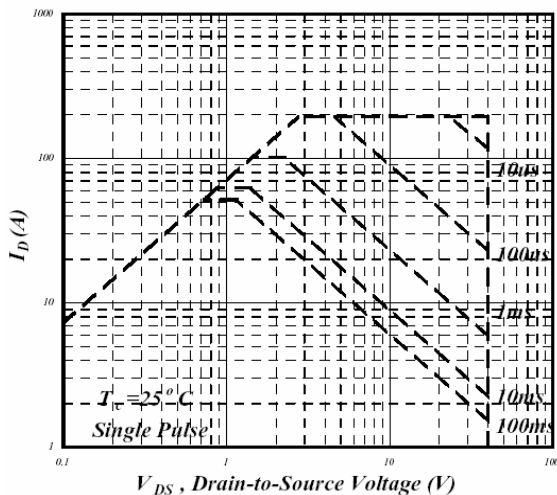


Fig 9. Maximum Safe Operating Area

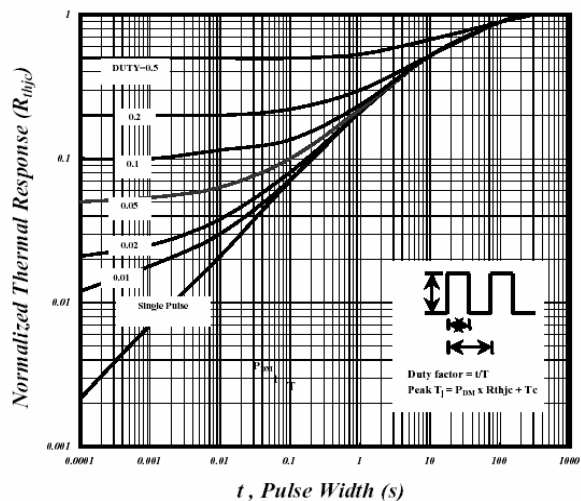


Fig 10. Effective Transient Thermal Impedance

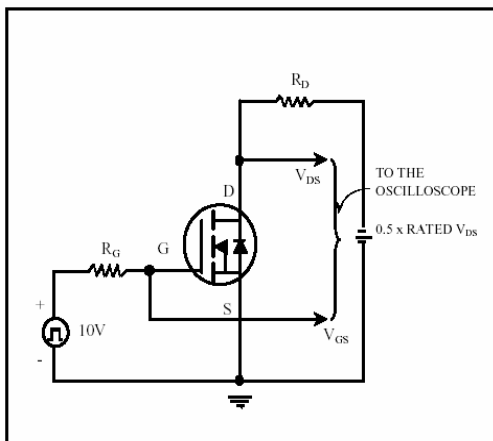


Fig 11. Switching Time Circuit

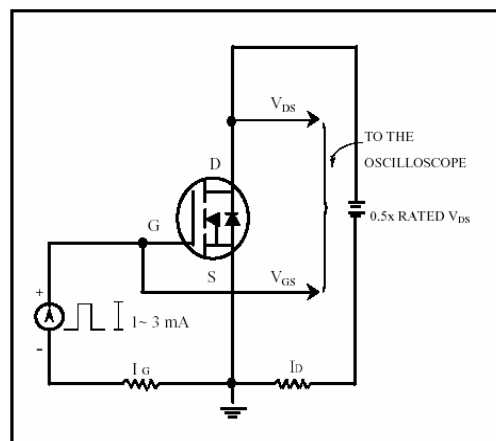


Fig 12. Gate Charge Circuit